RENESAS

HD74LV374A

Octal Edge-Triggered D-type Flip-Flops with 3-state Outputs

REJ03D0332-0200Z (Previous ADE-205-275 (Z)) Rev.2.00 Jun. 25, 2004

Description

The HD74LV374A has eight edge trigger D type flip flops with three state outputs in a 20 pin package. Data at the D inputs meeting set up requirements, are transferred to the Q outputs on positive going transitions of the clock input. When the clock input goes low, data at the D inputs will be retained at the outputs until clock input returns high again. When a high logic level is applied to the output control input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements. Low-voltage and high-speed operation is suitable for the battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

Features

- $V_{CC} = 2.0 \text{ V}$ to 5.5 V operation
- All inputs V_{IH} (Max.) = 5.5 V (@V_{CC} = 0 V to 5.5 V)
- All outputs V_0 (Max.) = 5.5 V (@V_{CC} = 0 V)
- Typical V_{OL} ground bounce < 0.8 V (@V_{CC} = 3.3 V, Ta = 25°C)
- Typical V_{OH} undershoot > 2.3 V (@V_{CC} = 3.3 V, Ta = 25°C)
- Output current $\pm 8 \text{ mA}$ (@V_{CC} = 3.0 V to 3.6 V), $\pm 16 \text{ mA}$ (@V_{CC} = 4.5 V to 5.5 V)
- Ordering Information

		Abbreviation	Taping Abbreviation (Quantity)
SOP–20 pin (JEITA)	FP–20DAV	FP	EL (2,000 pcs/reel)
SOP–20 pin (JEDEC)	FP-20DBV	RP	EL (1,000 pcs/reel)
TSSOP–20 pin	TTP-20DAV	Т	ELL (2,000 pcs/reel)
ξ	SOP-20 pin (JEDEC)	SOP–20 pin (JEDEC) FP–20DBV	SOP-20 pin (JEITA)FP-20DAVFPSOP-20 pin (JEDEC)FP-20DBVRP

Note: Please consult the sales office for the above package availability.

Function Table

Inputs

ŌĒ	CLK	D	Output Q
Н	Х	Х	Z
L	\uparrow	L	L
L	\uparrow	Н	Н
L	\downarrow	Х	Q ₀

Note: H: High level

L: Low level

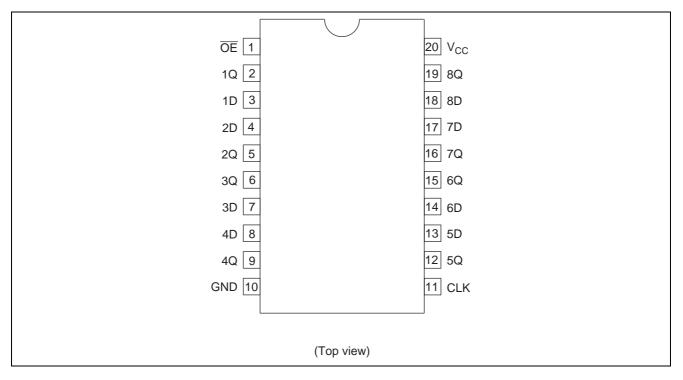
X: Immaterial

Z: High impedance

Q₀: Output level before the indicated steady state input conditions were established.



Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V _{CC}	–0.5 to 7.0	V	
Input voltage range*1	VI	–0.5 to 7.0	V	
Output voltage range*1, 2	Vo	-0.5 to V _{CC} + 0.5	V	Output: H or L
		-0.5 to 7.0		V _{CC} : OFF or Output: Z
Input clamp current	I _{IK}	-20	mA	V ₁ < 0
Output clamp current	l _{ок}	±50	mA	$V_{\rm O}$ < 0 or $V_{\rm O}$ > $V_{\rm CC}$
Continuous output current	lo	±35	mA	$V_{O} = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I_{CC} or I_{GND}	±70	mA	
Maximum power dissipation at	PT	835	mW	SOP
Ta = 25°C (in still air)* ³		757		TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. This value is limited to 5.5 V maximum.

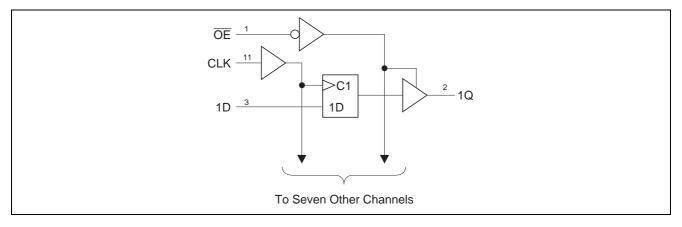
3. The maximum package power dissipation was calculated using a junction temperature of 150°C.



Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	Vcc	2.0	5.5	V	
Input voltage range	VI	0	5.5	V	
Output voltage range	Vo	0	V _{CC}	V	H or L
		0	5.5		High impedance state
Output current	I _{OH}	_	-50	μΑ	V _{CC} = 2.0 V
		_	-2	mA	V_{CC} = 2.3 to 2.7 V
		_	-8		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	-16		V_{CC} = 4.5 to 5.5 V
	I _{OL}	_	50	μΑ	V _{CC} = 2.0 V
		_	2	mA	V_{CC} = 2.3 to 2.7 V
		_	8		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		_	16		V_{CC} = 4.5 to 5.5 V
Input transition rise or fall rate	$\Delta t / \Delta v$	0	200	ns/V	V_{CC} = 2.3 to 2.7 V
		0	100		$V_{CC} = 3.0$ to 3.6 V
		0	20		$V_{CC} = 4.5$ to 5.5 V
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Logic Diagram



DC Electrical Characteristics

Ta = ·	-40 to	85°C

Item	Symbol	V _{cc} (V)*	Min	Тур	Max	Unit	Test Conditions
Input voltage	VIH	2.0	1.5	_	_	V	
		2.3 to 2.7	$V_{CC} \times 0.7$	_	_		
		3.0 to 3.6	$V_{CC} \times 0.7$		_	_	
		4.5 to 5.5	$V_{CC} \times 0.7$		_	_	
	VIL	2.0	_	_	0.5		
		2.3 to 2.7	_	_	$V_{CC} \times 0.3$		
		3.0 to 3.6	_	_	$V_{CC} \times 0.3$		
		4.5 to 5.5	_	_	$V_{CC} \times 0.3$		
Output voltage	V _{OH}	Min to Max	$V_{CC} - 0.1$	_	_	V	I _{OH} = –50 μA
		2.3	2.0	_	_	_	I _{OH} = -2 mA
		3.0	2.48	_	_	_	I _{OH} = —8 mA
		4.5	3.8	_	_	_	I _{OH} = -16 mA
	V _{OL}	Min to Max	_	_	0.1		I _{OL} = 50 μA
		2.3	_	_	0.4		$I_{OL} = 2 \text{ mA}$
		3.0	_	_	0.44		$I_{OL} = 8 \text{ mA}$
		4.5	_	_	0.55		I _{OL} = 16 mA
Input current	I _{IN}	0 to 5.5	_	_	±1	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Off-state output current	I _{OZ}	5.5		_	±5	μΑ	$V_{O} = V_{CC}$ or GND
Quiescent supply current	I _{CC}	5.5	_	—	20	μΑ	$V_{IN} = V_{CC}$ or GND, $I_0 = 0$
Output leakage current	I _{OFF}	0	_	_	5	μΑ	$V_{\rm I}$ or $V_{\rm O}$ = 0 to 5.5 V
Input capacitance	CIN	3.3	_	2.9	_	pF	$V_{I} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.



Switching Characteristics

									v	$CC = 2.3 \pm 0.2$
		Ta =	25°C		Ta = -4	0 to 85°C		Test	FROM	то
ltem	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Maximum clock	t _{max}	60	105	_	50	_	MHz	C∟ = 15 pF		
frequency		50	85	_	40	—	_	$C_L = 50 \text{ pF}$		
Propagation	t _{PLH}	_	9.7	16.3	1.0	19.0	ns	$C_L = 15 \text{ pF}$	CLK	Q
delay time	t _{PHL}	_	11.8	19.3	1.0	23.0	_	$C_L = 50 \text{ pF}$		
Enable time	t _{ZH}	—	8.9	15.9	1.0	19.0	ns	$C_L = 15 \text{ pF}$	OE	Q
	t _{ZL}	—	10.9	18.8	1.0	22.0		$C_L = 50 \text{ pF}$		
Disable time	t _{HZ}	_	6.3	12.6	1.0	15.0	ns	$C_L = 15 \text{ pF}$	OE	Q
	t _{LZ}	_	8.2	17.3	1.0	19.0	_	$C_L = 50 \text{ pF}$		
Setup time	t _{SU}	5.0	_	_	5.5	_	ns		Data befo	ore CLK ↑
Hold time	t _h	2.5	_		2.5	_	ns		Data afte	r CLK ↑
Pulse width	t _w	6.0		_	7.0	_	ns		CLK: "H"	or "L"

 $V_{CC}=3.3\pm0.3~V$

		Ta =	25°C		Ta = –4	0 to 85°C		Test	FROM	то
ltem	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Maximum clock	t _{max}	80	150	_	70	_	MHz	$C_L = 15 \text{ pF}$		
frequency		55	110	—	50	—		$C_L = 50 \text{ pF}$		
Propagation	t _{PLH}	_	6.8	12.7	1.0	15.0	ns	$C_L = 15 \text{ pF}$	CLK	Q
delay time	t _{PHL}		8.3	16.2	1.0	18.5		$C_L = 50 \text{ pF}$		
Enable time	t _{ZH}	_	6.3	11.0	1.0	13.0	ns	$C_L = 15 \text{ pF}$	OE	Q
	t _{ZL}		7.7	14.5	1.0	16.5		$C_L = 50 \text{ pF}$		
Disable time	t _{HZ}	_	4.7	10.5	1.0	12.5	ns	$C_L = 15 \text{ pF}$	OE	Q
	t _{LZ}	_	5.9	14.0	1.0	16.0		$C_L = 50 \text{ pF}$		
Setup time	ts∪	4.5	_	_	4.5	—	ns		Data befo	ore CLK ↑
Hold time	t _h	2.0			2.0		ns		Data afte	r CLK ↑
Pulse width	t _w	5.0	_	_	5.5	_	ns		CLK: "H"	or "L"

V _{CC} =	50+	05 V
v cc -	$5.0 \pm$	0.5 V

										ee
		Ta =	25°C		Ta = -4	0 to 85°C		Test	FROM	то
ltem	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions	(Input)	(Output)
Maximum clock	t _{max}	130	205	_	110	_	MHz	$C_L = 15 \text{ pF}$		
frequency		85	170	_	75	_	_	$C_L = 50 \text{ pF}$		
Propagation	t _{PLH}	_	4.9	8.1	1.0	9.5	ns	C∟ = 15 pF	CLK	Q
delay time	t _{PHL}	_	5.9	10.1	1.0	11.5	_	$C_L = 50 \text{ pF}$		
Enable time	t _{ZH}		4.6	7.6	1.0	9.0	ns	C∟ = 15 pF	ŌĒ	Q
	t _{ZL}	_	5.5	9.6	1.0	11.0	_	$C_L = 50 \text{ pF}$		
Disable time	t _{HZ}	_	3.4	6.8	1.0	8.0	ns	C∟ = 15 pF	ŌĒ	Q
	t _{LZ}	_	4.0	8.8	1.0	10.0	_	$C_L = 50 \text{ pF}$		
Setup time	t _{su}	3.0	_		3.0	_	ns		Data befo	ore CLK ↑
Hold time	t _h	2.0			2.0	_	ns		Data afte	er CLK ↑
Pulse width	tw	5.0	_	_	5.0	_	ns		CLK: "H"	or "L"

 $V_{CC}=2.5\pm0.2~V$

Output-skew Characteristics

			Ta = 25	5°C	Ta = -4	0 to 85°C	
Item	Symbol	$V_{CC} = (V)$	Min	Max	Min	Max	Unit
Output skew	t _{sk (O)}	2.3 to 2.7		2.0		2.0	ns
		3.0 to 3.6	_	1.5	_	1.5	
		4.5 to 5.5		1.0		1.0	

Note: Skew between any outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

Operating Characteristics

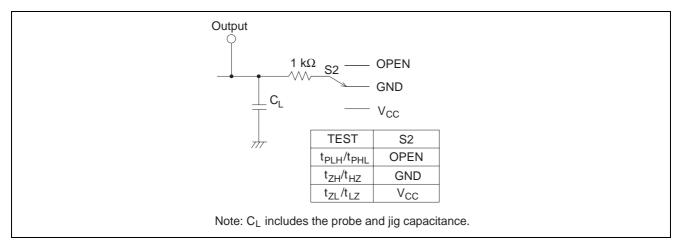
							$C_L = 50 \text{ pF}$	
			Ta = 25°C					
ltem	Symbol	$V_{CC} = (V)$	Min	Тур	Max	Unit	Test Conditions	
Power dissipation capacitance	CPD	3.3	_	21.1	_	pF	f = 10 MHz	
		5.0	_	22.8	_			

Noise Characteristics

 $C_L = 50 \text{ pF}$

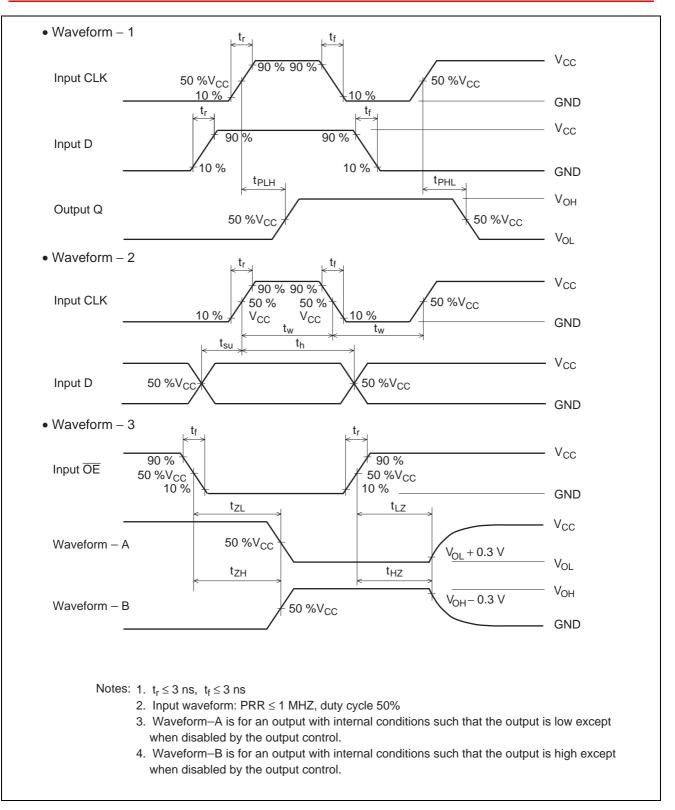
Item	Symbol	V _{cc} = (V)	Ta = 25°C				
			Min	Тур	Max	Unit	Test Conditions
Quiet output, maximum dynamic V _{OL}	V _{OL (P)}	3.3	—	0.6	0.8	V	
Quiet output, minimum dynamic V _{OL}	$V_{OL (V)}$	3.3	—	-0.5	-0.8	V	
Quiet output, minimum dynamic V _{OH}	$V_{OH (V)}$	3.3	—	2.9	_	V	
High-level dynamic input voltage	V _{IH (D)}	3.3	2.31	_	_	V	
Low-level dynamic input voltage	V _{IL (D)}	3.3	—	—	0.99	V	

Test Circuit



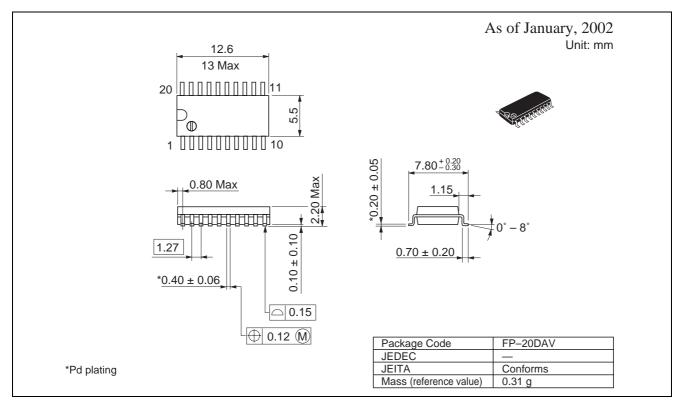


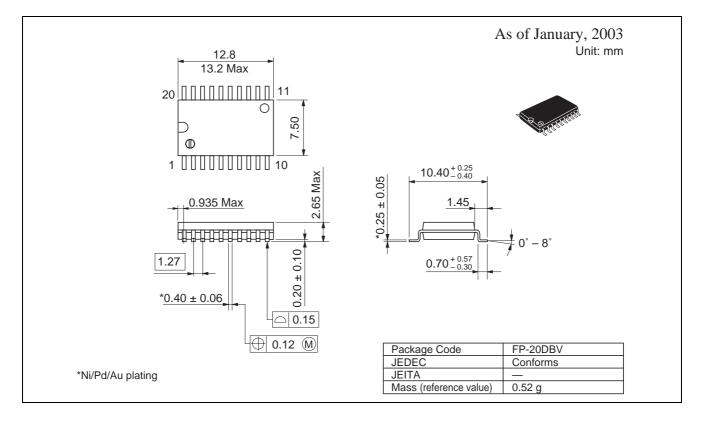
 $C_L = 50 \text{ pF}$



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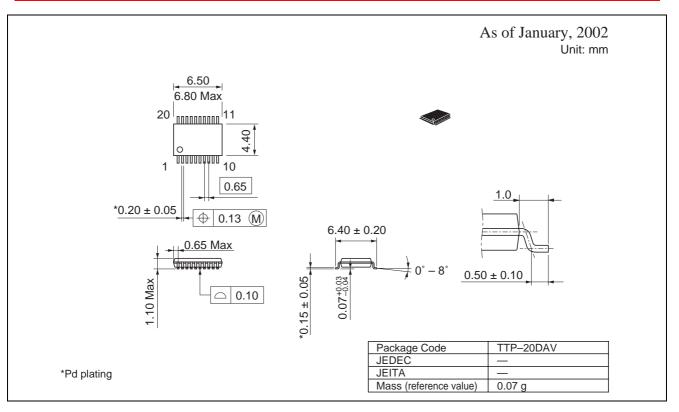
Package Dimensions





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